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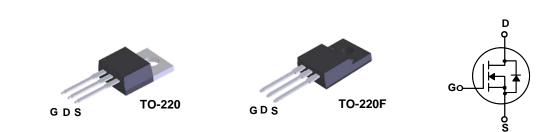
FQP7N65C / FQPF7N65C N-Channel QFET[®] MOSFET 650 V, 7 A, 1.4 Ω

Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor®'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 7 A, 650 V, $R_{DS(on)}$ =1.4 $\Omega(Max.)@V_{GS}$ =10 V, I_D =3.5 A
- Low Gate Charge (Typ. 28 nC)
- Low C_{rss} (Typ. 12 pF)
- 100% Avalanche Tested



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQP7N65C	FQPF7N65C	Unit
V _{DSS}	Drain-Source Voltage		650		V
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		7	7 *	А
	- Continuous (T _C = 100°C)		4.2	4.2 *	А
I _{DM}	Drain Current - Pulsed	(Note 1)	28	28 *	А
V _{GSS}	Gate-Source Voltage		± 30		V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	212		mJ
I _{AR}	Avalanche Current	(Note 1)	7		А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	1.6		mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5		V/ns
P _D	Power Dissipation (T _C = 25°C) - Derate above 25°C		160	52	W
			1.28	0.42	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150		°C
т	Maximum lead temperature for soldering purposes,		300		°C
Τ _L	1/8" from case for 5 seconds				
Drain current lim	ited by maximum junction temperature.		-1		

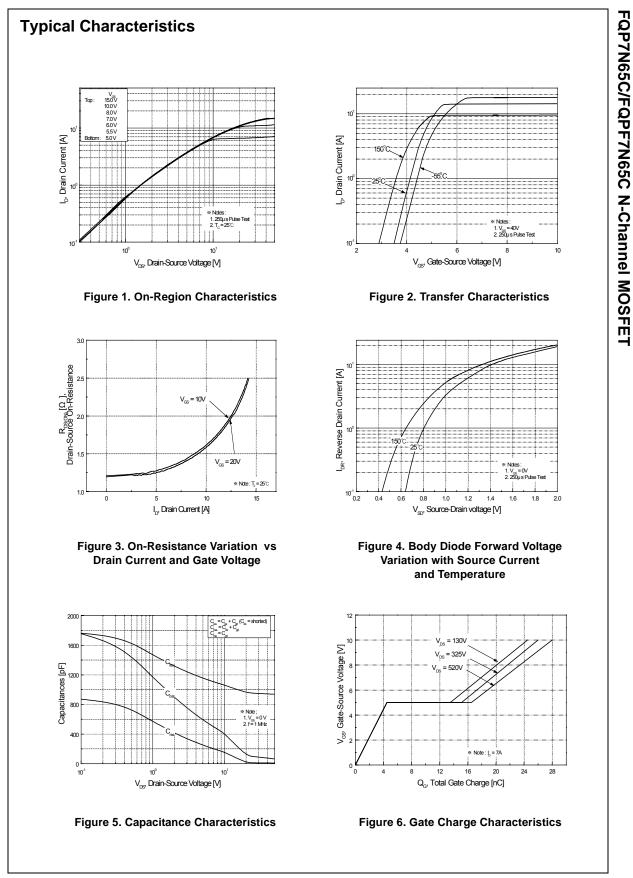
Thermal Characteristics

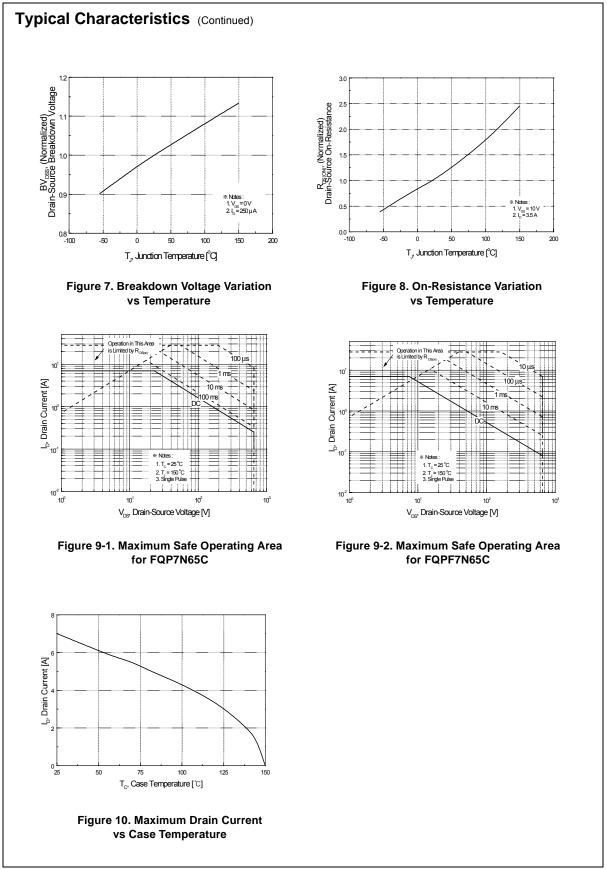
Symbol	Parameter	FQP7N65C	FQPF7N65C	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.78	2.4	°C/W	
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink Typ.	0.5		°C/W	
R _{0JA} Thermal Resistance, Junction-to-Ambient		62.5	62.5	°C/W	

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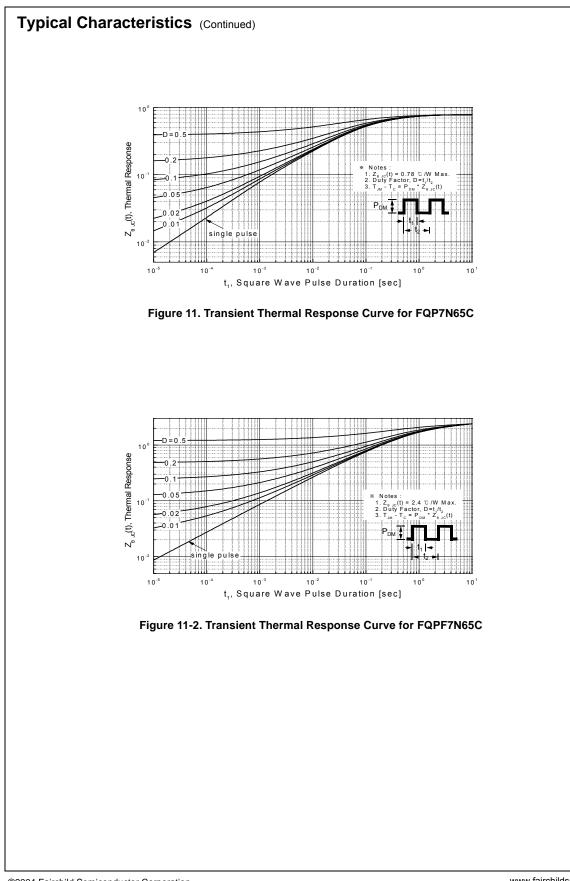
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage $V_{GS} = 0 \text{ V}, \text{ I}_D = 250 \mu\text{A}$		650			V
ΔBV _{DSS} ΔT _{.1}	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu$ A, Referenced to 25°C		0.8		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 650 V, V _{GS} = 0 V			1	μA
		V _{DS} = 520 V, T _C = 125°C			10	μΑ
GSSF	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
GSSR	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V		-	-100	nA
On Cha	racteristics					
/ _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 3.5 A		1.2	1.4	Ω
JFS	Forward Transconductance	V _{DS} = 40 V, I _D = 3.5 A (Note 4	l)	8		S
Jynam C _{iss}	ic Characteristics			955	1245	pF
S _{oss}	Output Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz		100	130	pF
Srss	Reverse Transfer Capacitance			100	16	pF
d(on)	ng Characteristics Turn-On Delay Time Turn-On Rise Time	$V_{DD} = 325 \text{ V}, \text{ I}_{D} = 7\text{A},$		20 50	50 110	ns ns
()	,					
d(off)	Turn-Off Delay Time	R _G = 25 Ω		90	190	ns
f	Turn-Off Fall Time	(Note 4, 5	5)	55	120	ns
ל ^מ	Total Gate Charge	V _{DS} = 520 V, I _D = 7A,		28	36	nC
Ω _{gs}	Gate-Source Charge	V _{GS} = 10 V		4.5		nC
Ω _{gd}	Gate-Drain Charge	(Note 4, 4	5)	12		nC
	aurea Diada Characteriation a	d Maximum Datinga				
s	ource Diode Characteristics an Maximum Continuous Drain-Source Dio				7	A
SM	Maximum Pulsed Drain-Source Diode F				28	A
/ _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = 7A$			1.4	V
rr	Reverse Recovery Time	$V_{GS} = 0 V, I_S = 7A,$		400		ns
2 _m	Reverse Recovery Charge	$dI_{\rm F} / dt = 100 {\rm A}/{\mu}{\rm s}$ (Note 4		3.3		μC
L = 8mH, I _A I _{SD} ≤ 7A, di/ Pulse Test :	ating : Pulse width limited by maximum junction temper $_{S} = 7A$, $V_{DD} = 50V$, $R_{G} = 25 \Omega$, Starting $T_{J} = 25^{\circ}C$ dt $\leq 200A/\mu s$, $V_{DD} \leq 8V_{DS}$, Starting $T_{J} = 25^{\circ}C$ Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$ independent of operating temperature	rature				

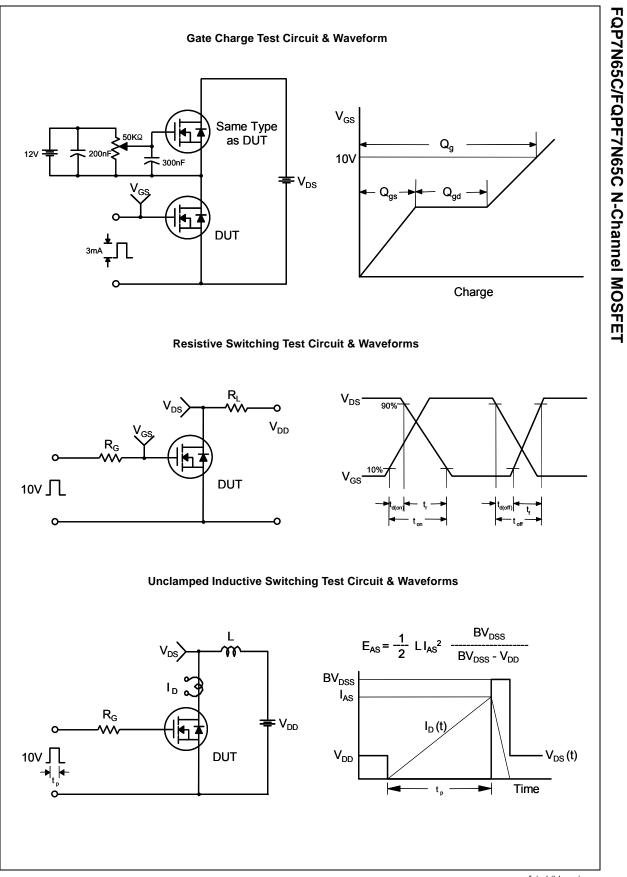
FQP7N65C/FQPF7N65C N-Channel MOSFET





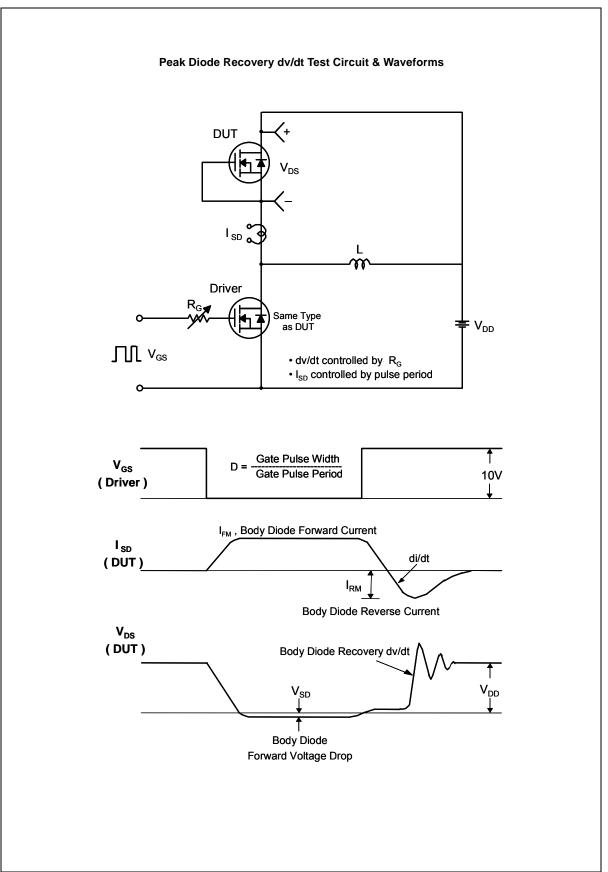
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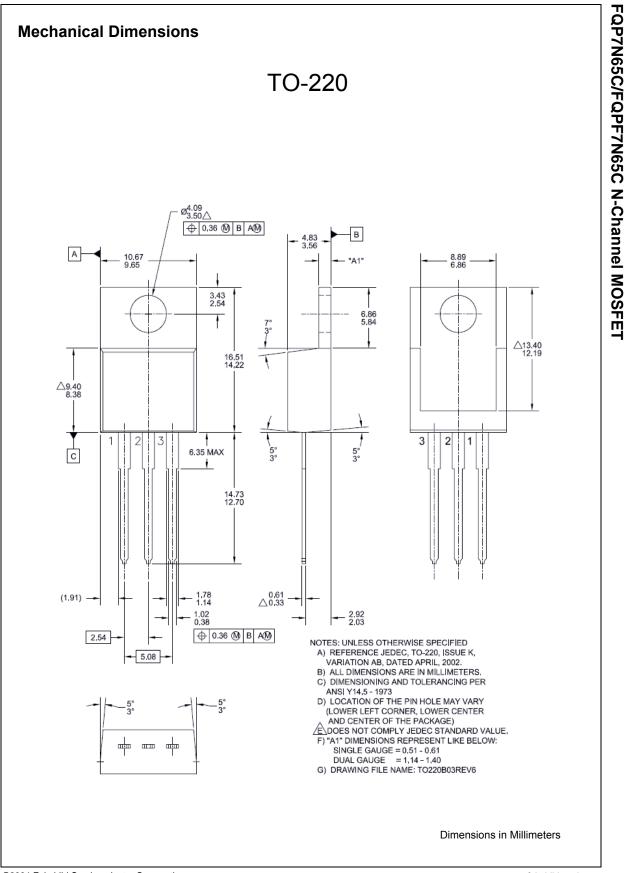




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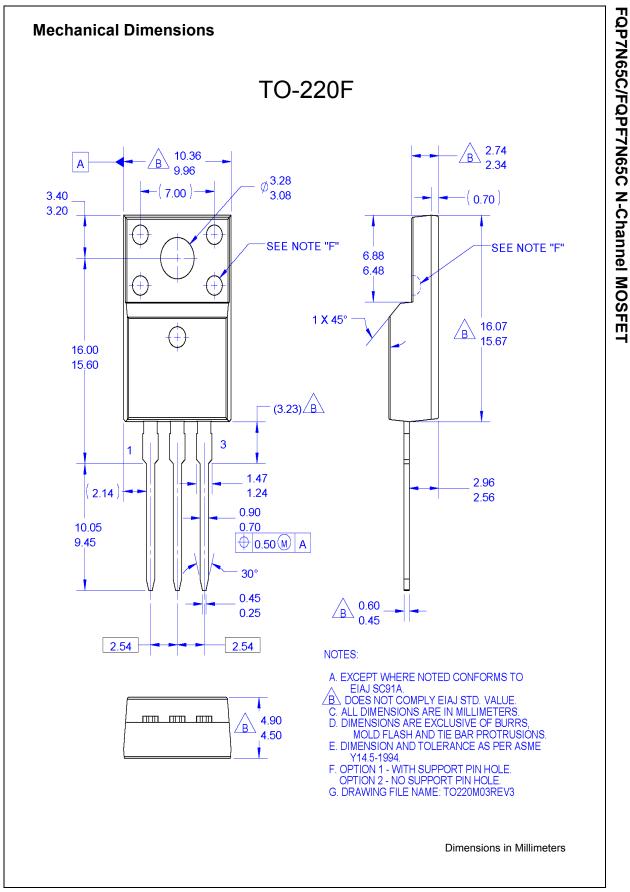
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